1-178317-5 ACTIVE

Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-178317-5

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.81 mm [.

15 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

Dynamic 3000 Series

View on TE.com >

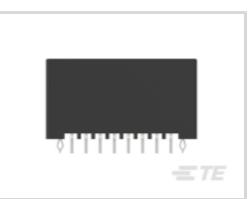


Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated











Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 1

Centerline (Pitch): 3.81 mm [.15 in]
PCB Mount Orientation: Vertical

All Header Assembly: Wire-to-Board, 15A, gold or tin plated (120)

Features

Product Type Features

Troduct Type realures			
Connector System	Wire-to-Board		
Header Type	Fully Shrouded		
Sealable	No		
Connector & Contact Terminates To	Printed Circuit Board		
PCB Connector Assembly Type	PCB Mount Header		
Configuration Features			
Number of Positions	8		
Number of Rows	1		
PCB Mount Orientation	Vertical		
Body Features			
Primary Product Color	Black		



Contact Mating Area Plating Material Thickness	2 μm[80 μin]
Contact Mating Area Plating Material Finish	Matte
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	15 A
Termination Features	

Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With

Housing Features

Housing Material	Polyester GF
Centerline (Pitch)	3.81 mm[.15 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
operating reinperature hange	33 103 O[07 ZZ1 1]

Operation/Application

Circuit Application	Power & Signal

Industry Standards

UL Flammability Rating UL 94V-0	- Flammability Rating	UL 94V-0	
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Packaging Features

Packaging Method	Box, Tube	
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

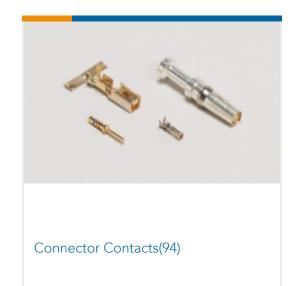
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Dynamic 3000 Series









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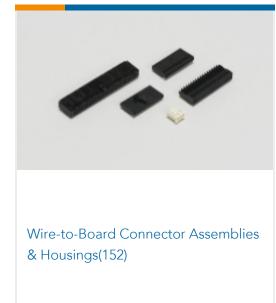








Standard Rectangular Connectors(2)



Customers Also Bought









Documents

Product Drawings
3.81 DYNAMIC 8P D3100S

Japanese

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_1-178317-5_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_1-178317-5_E.3d_igs.zip

English

Customer View Model

ENG_CVM_1-178317-5_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English

Agency Approvals

TUV Certificate

English

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Dynamic 3000 Series

